

# FY2025 First Quarter Financial Results July 17, 2025

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**DISCO CORPORATION** 

## FY2025 1Q Earnings Results



	FY2025
Billions of Yen	1Q
Net Sales	89.9
Gross Profit	61.3
Gross Profit Margin	68.1%
SG&A	26.8
Operating Income	34.5
Ordinary Income	34.0
Ordinary Income Margin	37.8%
Income before income taxes and minority interests	33.7
Net Income	23.8

FY2024	QoQ		
4Q	Amount	(%)	
120.7	-30.8	-25.5%	
84.2	-23.0	-27.3%	
69.8%	-1.7p	-	
32.5	-5.7	-17.6%	
51.7	-17.3	-33.4%	
51.9	-17.9	-34.4%	
43.0%	-5.2p	-	
51.5	-17.9	-34.7%	
38.6	-14.9	-38.5%	

FY2024	Yo	Υ
1Q	Amount	(%)
82.8	7.1	8.6%
57.7	3.6	6.2%
69.7%	-1.6p	-
24.3	2.5	10.1%
33.4	1.1	3.3%
33.6	0.4	1.1%
40.6%	<b>-</b> 2.8p	-
33.5	0.2	0.6%
23.7	0.1	0.2%

Sales:

GP margin:

SG&A:

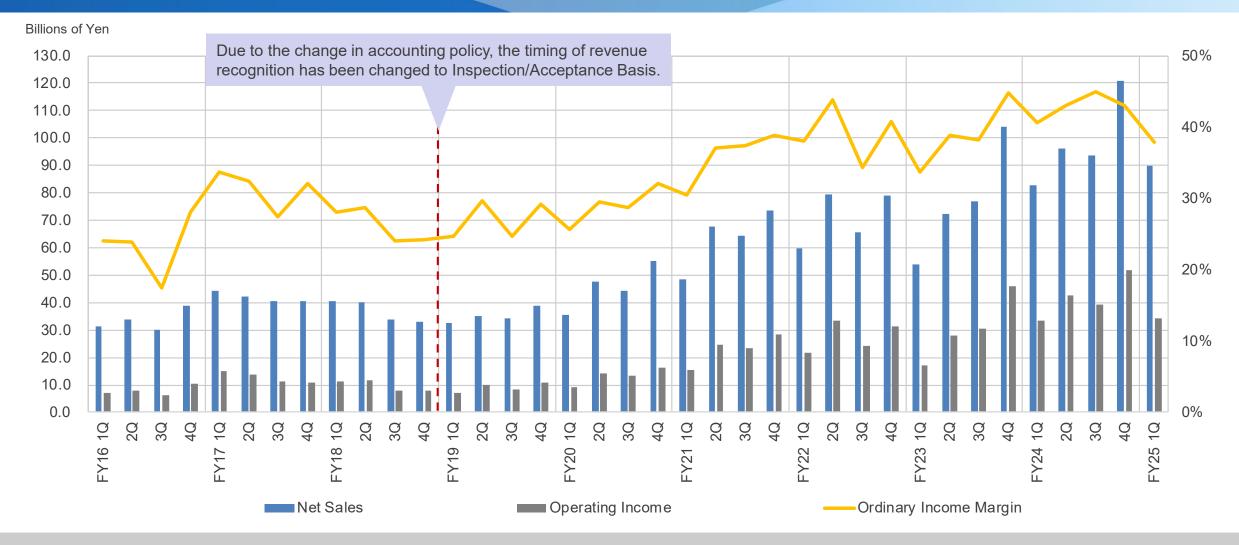
YoY increased due to high level of shipments and progress in equipment inspection/acceptance.

YoY decreased due to the exchange rate, although high value-added products contributed.

YoY increased mainly due to personnel and R&D expenses.

# **Quarterly Financial Results**

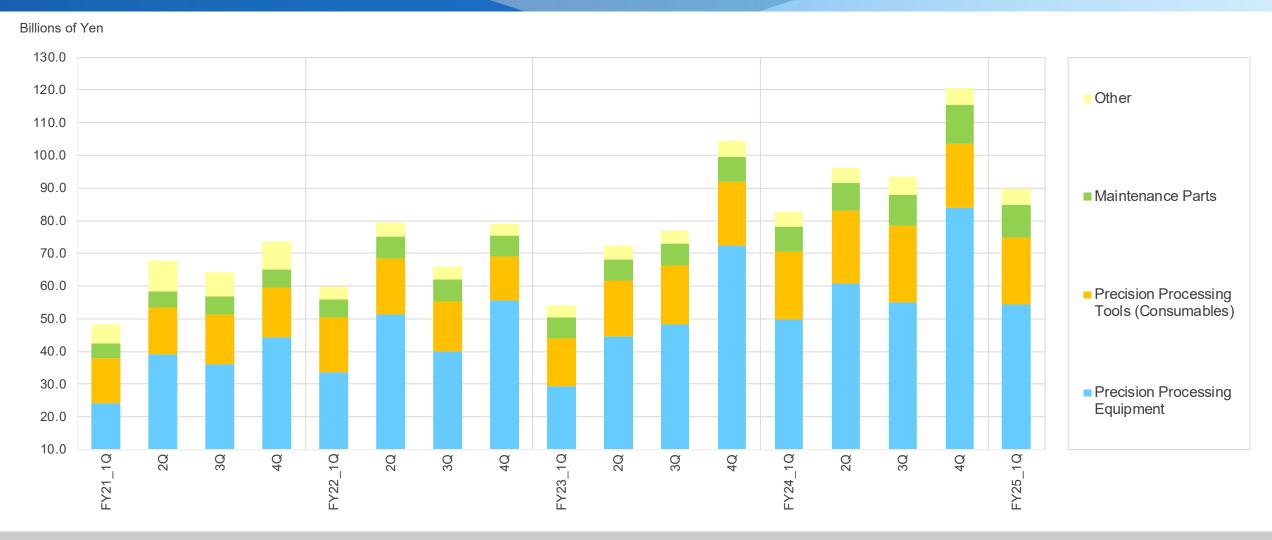




Operating income margin dropped below 40% for the first time in 6 quarters, but remained at a high level (FY25\_1Q Operating income margin 38.3%, Ordinary income margin 37.8%, Net income margin 26.4%)

# Quarterly Sales Breakdown by Product

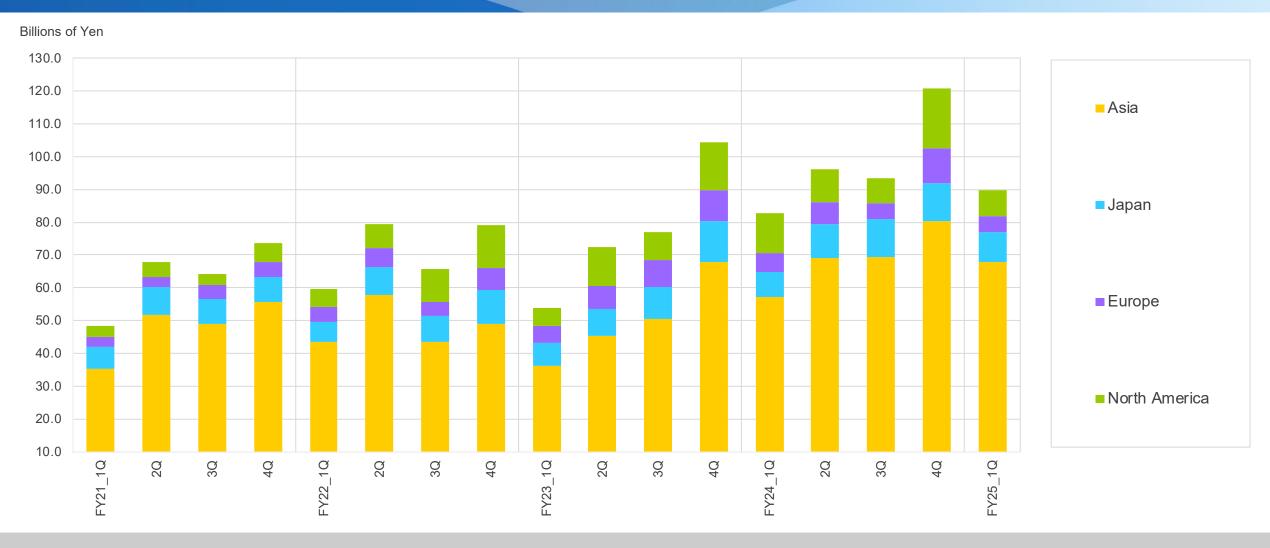




Note: Composition percentages are listed as additional information on the DISCO website.

# Quarterly Sales Breakdown by Region

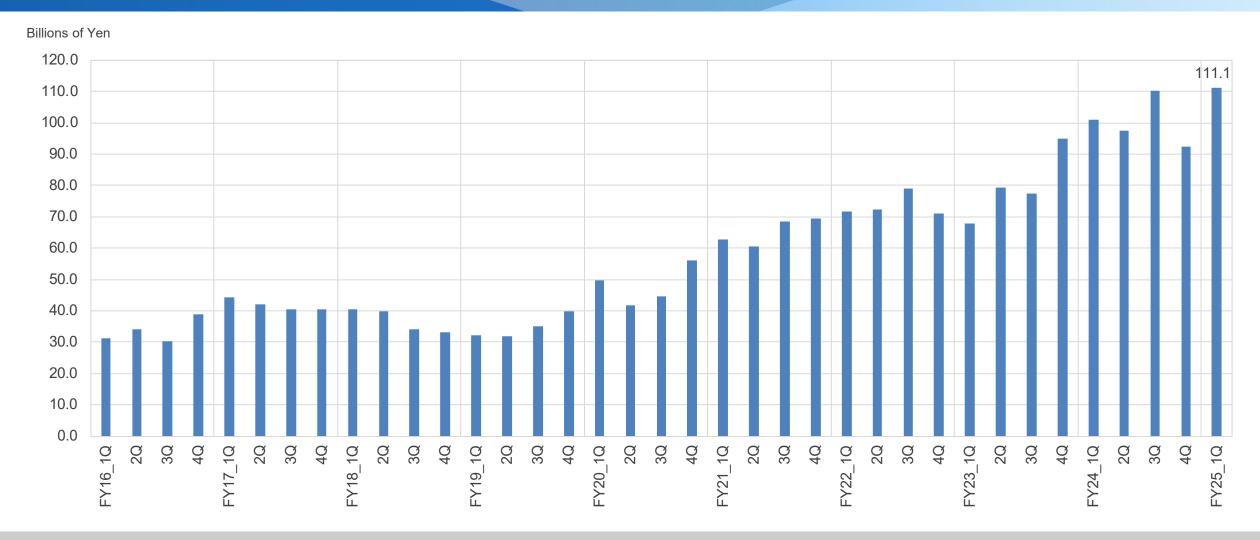




FY25\_1Q Overseas sales ratio: 89.9%

# **Quarterly Shipments**

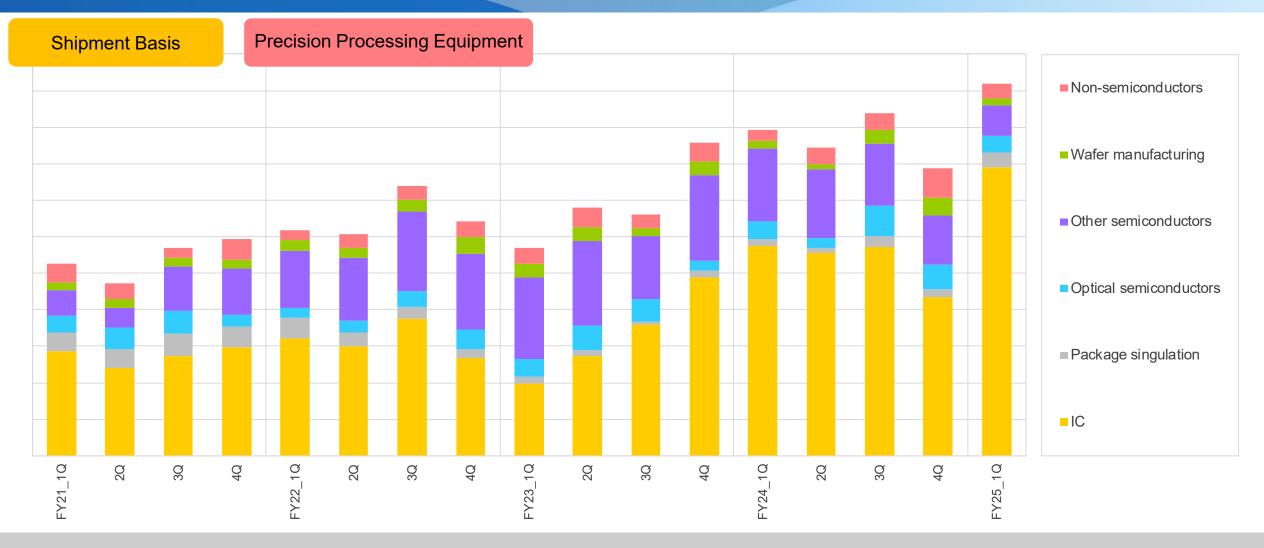




FY25\_1Q Shipment volume: approx. 111.1 billion yen

## Precision Processing Equipment: Sales by Application



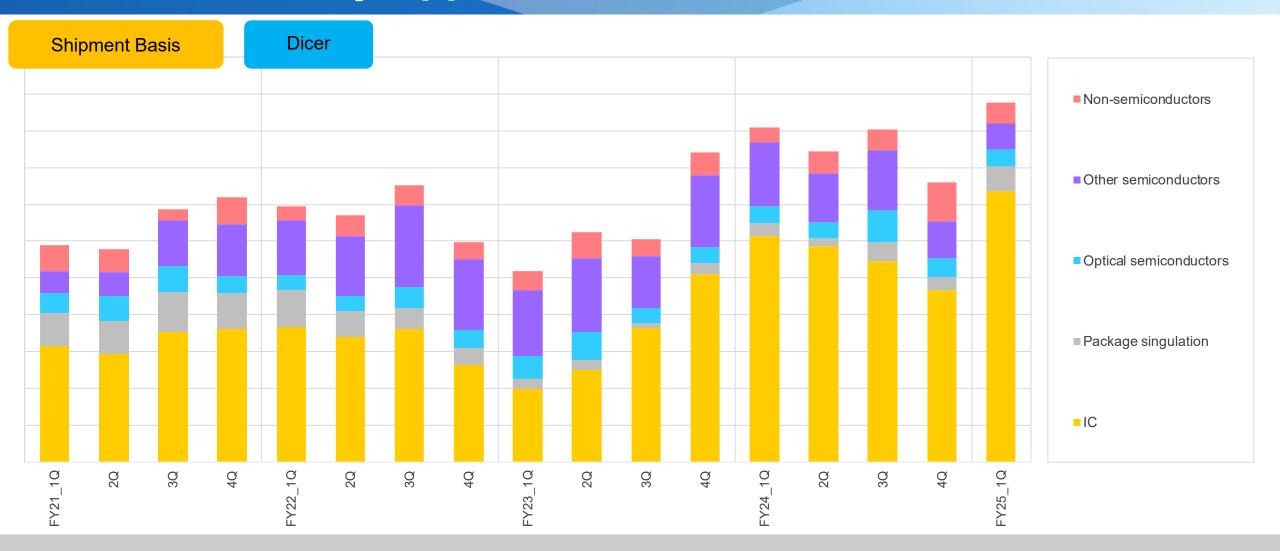


QoQ YoY Increased for IC mainly for generative AI, and was a record high for equipment sales as a whole.

Although a decrease for power semiconductors (other semiconductors) was seen, increased for IC mainly for generative AI.

# Dicer: Sales by Application



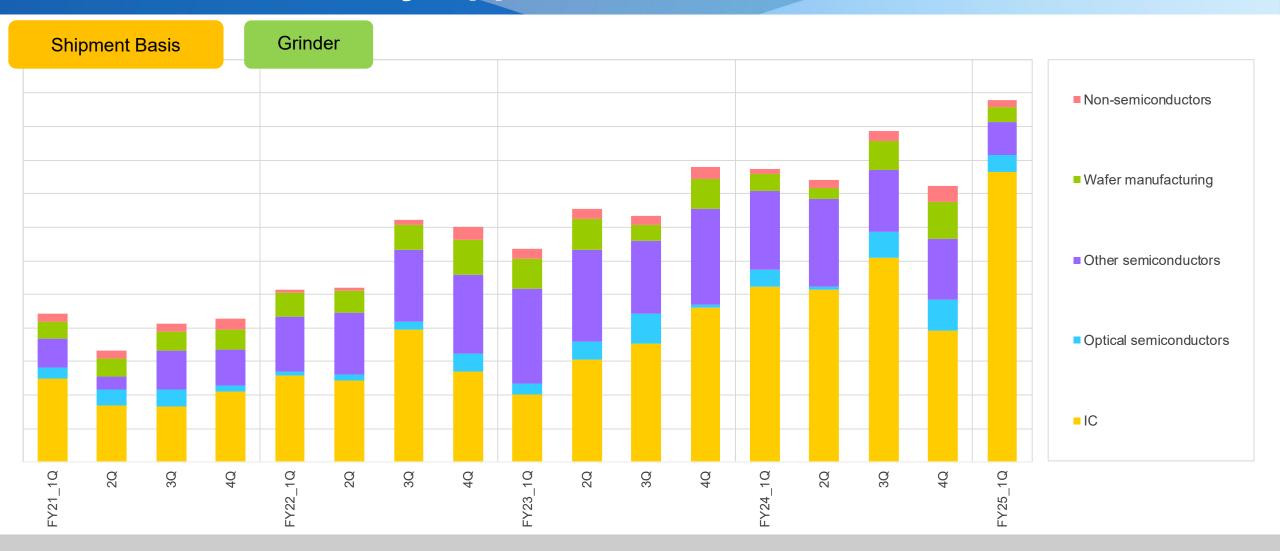


QoQ Increased for IC mainly for generative AI.

YoY Although a decrease for power semiconductors (other semiconductors) was seen, increased for IC mainly for generative Al.

# **Grinder: Sales by Application**



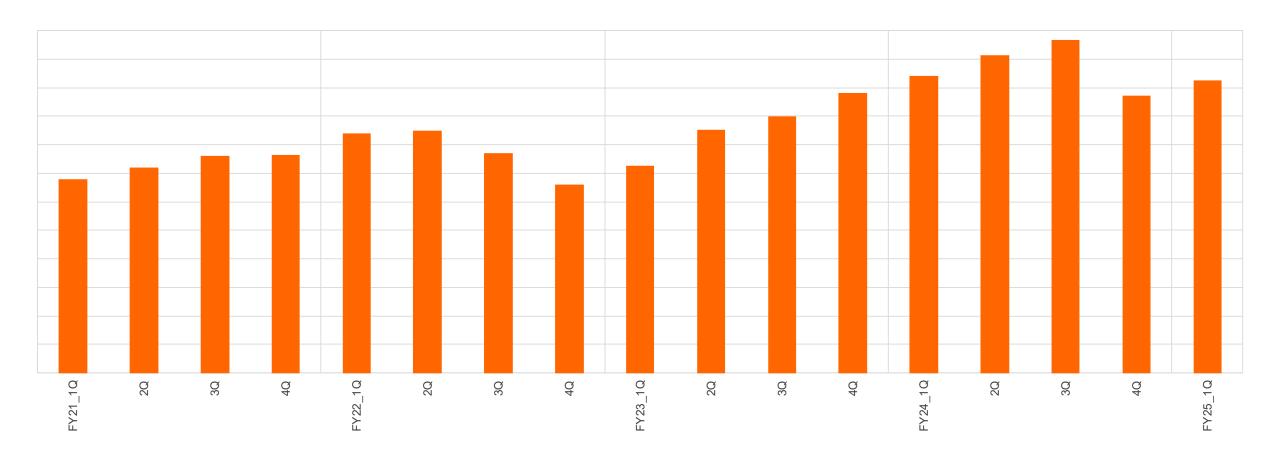


QoQ Increased for IC mainly for generative AI.

YoY Although a decrease for power semiconductors (other semiconductors) was seen, increased for IC mainly for generative Al.

# Precision Processing Tools Sales (Consumables)





Precision processing tool (consumables) shipments remained steady linked to stable customer facility operation rates.

# **Balance Sheet (Summary)**



	FY2025	FY	2024	
Billions of Yen	1Q	4	4Q	Amount
Cash and deposits	198.5		229.2	-30.7
Notes and account receivable	48.0		43.2	4.8
Inventories	141.1		139.0	2.1
Total current assets	391.1		424.5	-33.4
Property, plant and equipment	206.6		204.0	2.6
Total noncurrent assets	229.0		229.6	-0.6
Total assets	620.1		654.1	-34.0
Current liabilities	134.1		160.4	-26.3
Noncurrent liabilities	1.0		1.0	0.0
Total liabilities	135.2		161.4	-26.2
Total net assets	484.9		492.7	-7.8
Total liabilities and net assets	620.1		654.1	-34.0
Equity Ratio	78.0%		75.1%	2.9p

Total assets: Liabilities: Net assets: Cash and deposits decreased significantly due to various payments such as dividend payouts. Decreased mainly due to income taxes payable, provision for bonuses, etc. Decreased mainly due to the dividend payout.

# **Earnings Forecast 2Q FY2025**



Billions of Yen Forecast

	FY24 1Q	2Q	3Q	4Q	FY25 1Q	2Q
Net Sales	82.8	96.2	93.6	120.7	89.9	91.2
Operating Income	33.4	42.6	39.1	51.7	34.5	33.2
Ordinary Income	33.6	41.4	42.0	51.9	34.0	33.2
Net Income	23.7	29.7	31.8	38.6	23.8	23.5
Operating Income Margin	40.3%	44.3%	41.8%	42.8%	38.4%	36.4%
Ordinary Income Margin	40.6%	43.0%	44.9%	43.0%	37.8%	36.4%
Net Income Margin	28.6%	30.9%	34.0%	32.0%	26.5%	25.8%
Shipment Figures	101.1	97.6	110.3	92.5	111.1	83.6

Assumed exchange rate for 2Q (Jul-Sep): 1 US dollar = 135 yen, 1 euro = 160 yen Currency sensitivity (annualized) US dollar: Approx. 1.6 billion yen, Euro: Approx. 0.1 billion yen

# **Dividend Policy and Dividend Payments**



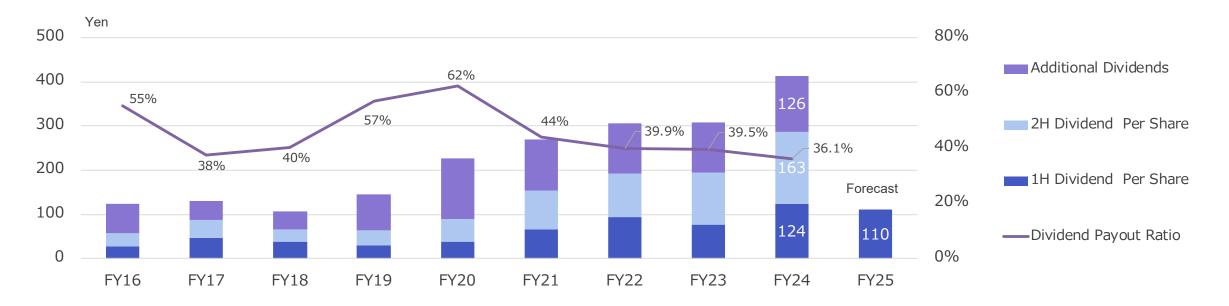
#### **Dividend Policy**

- Decisions concerning the distribution of surpluses are made at the general shareholders meetings, in the case of final dividends, and by the Board of Directors, in the case of interim dividends.
- 1. Adopting a performance-linked dividend policy and aiming at giving clearer priority to shareholder returns, our target dividend payout ratio is 25% of the consolidated half-yearly net income.

  There will be interim and final dividends, each of which will be equivalent to 25% of the half-yearly consolidated net income.
- 2. Irrespective of the level of income, a reliable dividend of ¥10 per half-year will be maintained. This means that the minimum yearly dividend will be ¥20.
- 3. Unless there is a loss, if the year-end balance of cash and deposits after payment of dividends and income taxes is greater than the projected funding requirements for the acquisition of technology resources, such as through patent purchases and investments in venture businesses, facility expansion, the retirement of interest-bearing debt, and other purposes, one-third of that surplus will be added to dividends.

#### [Remarks]

The ¥20 payout stipulated in our stable dividend policy may be reviewed if there are consolidated net losses for three consecutive years.

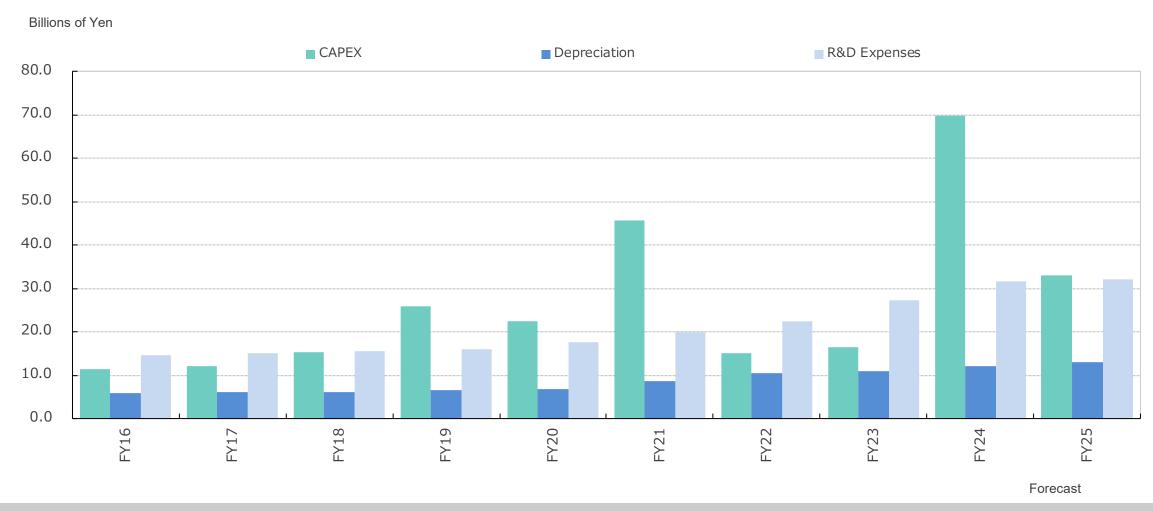


## FY25 (forecast) Interim: 110 yen Year-end: undecided

\*The Company implemented a stock split in the proportion of 1 share into 3 shares effective as of April 1, 2023 (The dividend trend before FY22 has been represented under the assumption that the applicable stock split has been done)

## **R&D/CAPEX Forecast**





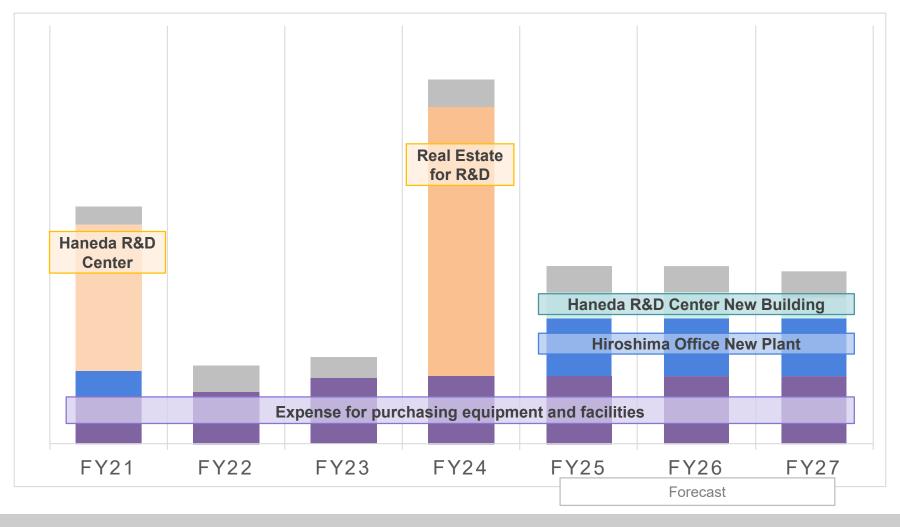
**FY25 Forecast** 

CAPEX: Approx. 33 billion yen; including rationalization investment, reconstruction of the Haneda R&D Center, and construction of a new plant. Depreciation: Approx. 13 billion yen

R&D Expenses: Approx. 32 billion yen; proactive research and development continues.

## **Breakdown of CAPEX**





Real Estate for R&D: Haneda R&D Center new building: Hiroshima Works new plant: Approx. 50 billion yen Approx. 14 billion yen Approx. 33 billion yen Payment timing: FY24
Payment timing: FY25~27
Payment timing: FY25~27

# Sales Forecast By Product



	Product		Forecast FY25_2Q (QoQ)
		Blade dicers	-30%
		Laser Saws	-45%
	Dicers		-35%
	Grinders		-35%
	Accessory	Equipment	-25%
Precisio	Precision Processing Equipment		-35%
Precision Processing Tools (Consumables)		5%	
Others			-15%



Reference Data

# **Data by Product**



Product	1Q				
Troduct	Composition	QoQ	YoY		
Precision Processing Equipment	68%	28%	14%		
Dicers	35%	29%	7%		
Blade Dicers	18%	38%	5%		
Laser Saws	18%	20%	10%		
Grinders	29%	31%	24%		
Accessory Equipment	3%	4%	5%		
Precision Processing Tools	19%	5%	-1%		
Others	14%	8%	9%		
Total	100%	20%	10%		

# Composition by Application



			FY24			
Product	Application	24-1Q	24-2Q	24-3Q	24-4Q	25-1Q
Dicers	IC	67%	69%	60%	62%	78%
	Package singulation	4%	3%	6%	4%	5%
	Optical semiconductors	5%	5%	10%	7%	5%
	Other semiconductors	19%	16%	18%	13%	7%
	Non-semiconductors	5%	7%	7%	14%	6%
Dicers		100%	100%	100%	100%	100%
Grinders	IC	60%	61%	62%	48%	80%
	Optical semiconductors	6%	1%	8%	11%	5%
	Other semiconductors	27%	31%	19%	22%	9%
	Wafer manufacturing	6%	4%	9%	14%	4%
	Non-semiconductors	2%	3%	3%	6%	2%
Grinders		100%	100%	100%	100%	100%

# **YoY by Application**



			FY24				
Product	Application	24-1Q	24-2Q	24-3Q	24-4Q	25-1Q	
Dicers	IC	210%	135%	50%	-8%	23%	
	Package singulation	23%	-15%	270%	7%	33%	
	Optical semiconductors	-26%	-46%	112%	26%	-5%	
	Other semiconductors	-3%	-33%	15%	-48%	-58%	
	Non-semiconductors	-17%	-13%	26%	65%	34%	
Dicers		75%	36%	49%	-10%	7%	
Grinders	IC	160%	68%	73%	-14%	66%	
	Optical semiconductors	46%	-86%	-15%	819%	-1%	
	Other semiconductors	-16%	-4%	-15%	-37%	-59%	
	Wafer manufacturing	-45%	-62%	79%	26%	-8%	
	Non-semiconductors	-50%	-24%	19%	31%	46%	
Grinders		37%	11%	34%	-6%	24%	

# **QoQ** by Application



			FY24			
Product	Application	24-1Q	24-2Q	24-3Q	24-4Q	25-1Q
Dicers	IC	20%	-4%	-7%	-14%	62%
	Package singulation	14%	-34%	119%	-35%	43%
	Optical semiconductors	10%	-12%	115%	-40%	-16%
	Other semiconductors	-11%	-22%	19%	-37%	-28%
	Non-semiconductors	-34%	46%	-3%	77%	-47%
Dicers		8%	-7%	7%	-16%	29%
Grinders	IC	14%	-2%	18%	-35%	120%
	Optical semiconductors	402%	-85%	952%	20%	-46%
	Other semiconductors	-17%	10%	-29%	-3%	-46%
	Wafer manufacturing	-45%	-29%	148%	29%	-59%
	Non-semiconductors	-59%	62%	24%	61%	-55%
Grinders		-1%	-4%	17%	-16%	31%

## **Composition by Region**



## Inspection/Acceptance Basis

Composition by Region	FY2024	FY2024						
	1Q	2Q	3Q	4Q	1Q			
Japan	9%	11%	12%	10%	10%			
North America	15%	10%	8%	15%	9%			
Asia	69%	72%	74%	66%	75%			
Singapore	6%	8%	8%	7%	7%			
Taiwan	16%	17%	19%	22%	27%			
Korea	14%	12%	9%	9%	9%			
China (Note 1)	32%	33%	37%	27%	30%			
Other	1%	1%	1%	2%	3%			
Europe	7%	7%	5%	9%	6%			
Total	100%	100%	100%	100%	100%			

Note 1: Including sales to local factories of foreign manufacturers



#### These materials

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#### Notation

The yearly accounting period from April of the current year to March of the following year is denoted by FY (Fiscal Year), and quarterly accounting periods are denoted by 1Q (April – June), 2Q (July – September), 3Q (October – December), and 4Q (January – March). Depending on the monetary unit, figures lower than the minimum unit may be rounded up or down, as a result of which the total sum may not match. Percentages are calculated based on the actual figures.

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